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## FQP2P40

# P-Channel QFET<sup>®</sup> MOSFET -400 V, -2.0 A, 6.5 $\Omega$

#### Description

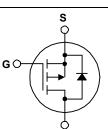
These P-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for electronic lamp ballast based on complimentary half bridge.

#### Features

- -2.0 A, -400 V,  $R_{DS(on)}$  = 6.5  $\Omega$  (Max.) @  $V_{GS}$  = -10 V
- Low Gate Charge (Typ. 10 nC)
- Low Crss (Typ. 6.5 pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability





Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

Symbol	Parameter	FQP2P40-F080	Unit	
V <sub>DSS</sub>	Drain-Source Voltage	-400	V	
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}$	-2.0	A	
	- Continuous (T <sub>C</sub> = 100	°C)	-1.27	Α
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	-8.0	A
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	120	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	-2.0	A
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	6.3	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-4.5	V/ns
PD	Power Dissipation ( $T_C = 25^{\circ}C$ )		63	W
	- Derate Above 25°C		0.51	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Ran	ge	-55 to +150	°C
Τ <sub>L</sub>	Maximum Lead Temperature for Solderin 1/8" from Case for 5 Seconds	g,	300	°C

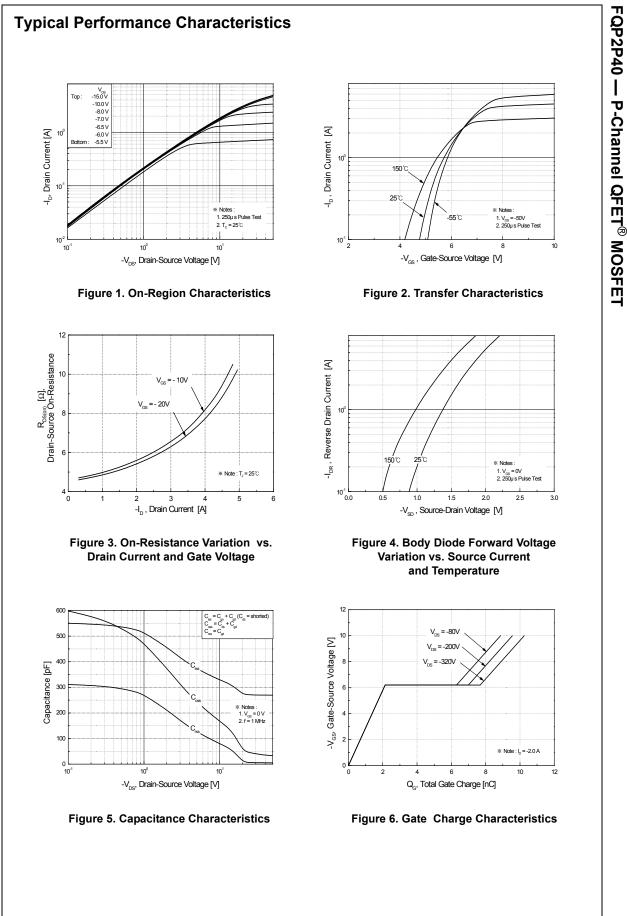
#### **Thermal Characteristics**

Symbol	Parameter	FQP2P40-F080	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	1.98	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

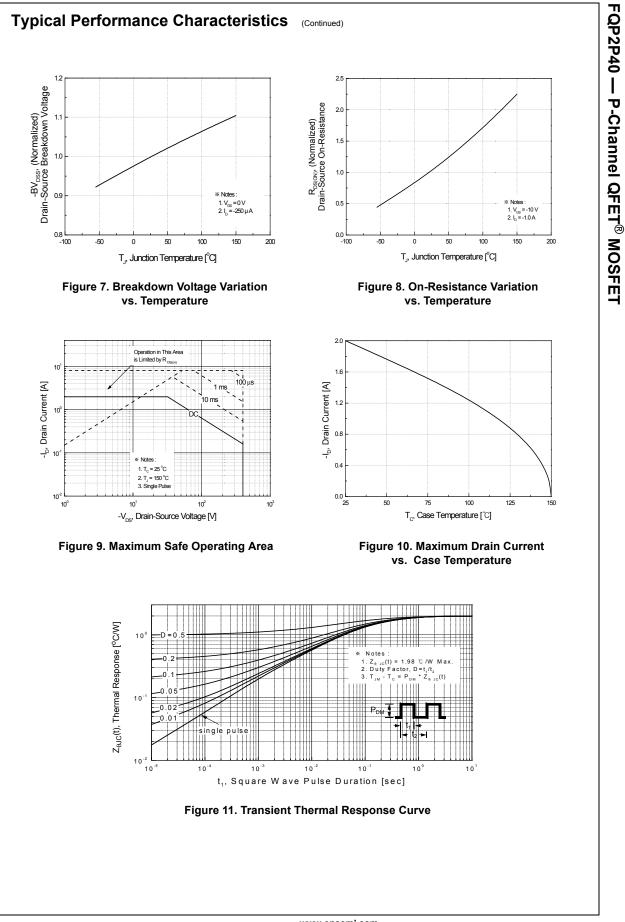
Part Number		Top Mark	Package	Packing Method	Reel Size	Tape Width		Qu	Quantity	
-QP2P40	2P40-F080 FQP2P40 TO-220		TO-220	Tube N/A		N/A		50	50 units	
lerica	l Cha	racteristics	T <sub>C</sub> = 25°C unle	ess otherwise noted.						
Symbol		Parameter		Test Conditi	ions	Min.	Тур.	Max.	Unit	
Off Cha	aracter	istics								
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage		V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA		-400			V		
$\Delta BV_{DSS}$	Breakdown Voltage Temperature Coefficient		$I_D = -250 \mu$ A, Referenced to 25°C							
$/\Delta T_J$						-		V/°C		
IDSS	Zero Gate Voltage Drain Current		V <sub>DS</sub> = -400 V, V <sub>GS</sub> = 0 V				-1	μA		
			$V_{DS} = -320 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$				-10	μA		
GSSF	Gate-B	Gate-Body Leakage Current, Forward		$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA	
I <sub>GSSR</sub>	Gate-B	Gate-Body Leakage Current, Reverse		$V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				100	nA	
			1							
On Cha										
V <sub>GS(th)</sub>		hreshold Voltage		$V_{DS} = V_{GS}, I_{D} = -250$	μA	-3.0		-5.0	V	
R <sub>DS(on)</sub>		Drain-Source sistance		$V_{GS}$ = -10 V, $I_{D}$ = -1.0	) A		5.0	6.5	Ω	
9 <sub>FS</sub>	Forwar	d Transconductance		$V_{DS}$ = -50 V, $I_{D}$ = -1.0	) A		1.42		S	
-	1	racteristics								
	I Innut C	apacitance		$V_{DS} = -25 V, V_{GS} = 0$	V,		270	350	pF	
		<b>a</b> "		$v_{\rm DS} = -25  v,  v_{\rm GS} = 0$				~~		
C <sub>oss</sub>	Output	Capacitance		v <sub>DS</sub> = -25 v, v <sub>GS</sub> = 0 f = 1.0 MHz			45	60	pF	
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Output	Capacitance e Transfer Capacitanc	e				45 6.5	60 8.5	pF pF	
C <sub>oss</sub> C <sub>rss</sub>	Output Revers	•	e				_			
C <sub>oss</sub> C <sub>rss</sub> Switch	Output Revers	e Transfer Capacitanc	e	f = 1.0 MHz			_			
C <sub>oss</sub> C <sub>rss</sub> Switch	Output Revers ing Ch Turn-O	e Transfer Capacitance	e	f = 1.0 MHz V <sub>DD</sub> = -200 V, I <sub>D</sub> = -2	.0 A,		6.5	8.5	pF	
C <sub>oss</sub> C <sub>rss</sub> Switch t <sub>d(on)</sub>	Output Revers ing Ch Turn-O Turn-O	e Transfer Capacitanc aracteristics n Delay Time	e	f = 1.0 MHz	.0 A,		6.5 9	8.5	pF ns	
C <sub>oss</sub> C <sub>rss</sub> Switch t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Output Revers ing Ch Turn-O Turn-O Turn-O	e Transfer Capacitanc aracteristics n Delay Time n Rise Time	e	f = 1.0 MHz V <sub>DD</sub> = -200 V, I <sub>D</sub> = -2	.0 A,		6.5 9 33	8.5 30 75	pF ns ns	
C <sub>oss</sub> C <sub>rss</sub> Switch t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Output Revers ing Ch Turn-O Turn-O Turn-O Turn-O	e Transfer Capacitanc aracteristics n Delay Time n Rise Time ff Delay Time	e	f = 1.0 MHz V <sub>DD</sub> = -200 V, I <sub>D</sub> = -2 V <sub>GS</sub> = -10 V, R <sub>G</sub> = 25	.0 A, 5 Ω (Note 4)		6.5 9 33 22	8.5 30 75 55	pF ns ns	
C <sub>oss</sub> C <sub>rss</sub> Switch t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Output Revers ing Ch Turn-O Turn-O Turn-O Turn-O Turn-O Total G	e Transfer Capacitance aracteristics n Delay Time n Rise Time ff Delay Time ff Fall Time	e	f = 1.0 MHz $V_{DD}$ = -200 V, I <sub>D</sub> = -2 $V_{GS}$ = -10 V, R <sub>G</sub> = 25 $V_{DS}$ = -320 V, I <sub>D</sub> = -2	.0 A, 5 Ω (Note 4)		9 33 22 25	8.5 30 75 55 60	ns ns ns ns	
C <sub>oss</sub> C <sub>rss</sub> <b>Switch</b> t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub>	Output Revers ing Ch Turn-O Turn-O Turn-O Turn-O Turn-O Turn-O Total G Gate-S	e Transfer Capacitance aracteristics n Delay Time n Rise Time ff Delay Time ff Fall Time ate Charge	e	f = 1.0 MHz V <sub>DD</sub> = -200 V, I <sub>D</sub> = -2 V <sub>GS</sub> = -10 V, R <sub>G</sub> = 25	.0 A, 5 Ω (Note 4)		6.5 9 33 22 25 10	8.5 30 75 55 60 13	ns ns ns ns nC	
C <sub>oss</sub> C <sub>rss</sub> <b>Switch</b> t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub>	Output Revers ing Ch Turn-O Turn-O Turn-O Turn-O Turn-O Turn-O Total G Gate-S	e Transfer Capacitance aracteristics n Delay Time n Rise Time ff Delay Time ff Fall Time ate Charge ource Charge	e	f = 1.0 MHz $V_{DD}$ = -200 V, I <sub>D</sub> = -2 $V_{GS}$ = -10 V, R <sub>G</sub> = 25 $V_{DS}$ = -320 V, I <sub>D</sub> = -2	.0 A, 5 Ω (Note 4)		9   33   22   25   10   2.1	8.5 30 75 55 60 13 	pF ns ns ns nc nC	
$\begin{array}{c} C_{oss} \\ \hline C_{rss} \\ \hline \end{array} \\ \hline \\ Switch \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ \hline \\ Q_g \\ \hline \\ Q_{gs} \\ \hline \\ Q_{gd} \\ \hline \end{array}$	Output Revers ing Ch Turn-O Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-D	e Transfer Capacitance aracteristics n Delay Time n Rise Time ff Delay Time ff Fall Time ate Charge ource Charge		f = 1.0 MHz $V_{DD}$ = -200 V, I <sub>D</sub> = -2 $V_{GS}$ = -10 V, R <sub>G</sub> = 25 $V_{DS}$ = -320 V, I <sub>D</sub> = -2 $V_{GS}$ = -10 V	.0 A, 5 Ω (Note 4) .0 A, (Note 4)		9   33   22   25   10   2.1	8.5 30 75 55 60 13 	pF ns ns ns nc nC	
$C_{oss}$ $C_{rss}$ <b>Switch</b> d(on) r d(off) f $Q_{g}$ $Q_{gs}$ $Q_{gd}$ <b>Drain-S</b>	Output Revers ing Ch Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-D	aracteristics n Delay Time n Rise Time ff Delay Time ff Fall Time ate Charge ource Charge orain Charge	istics an	f = 1.0 MHz $V_{DD}$ = -200 V, I <sub>D</sub> = -2 $V_{GS}$ = -10 V, R <sub>G</sub> = 25 $V_{DS}$ = -320 V, I <sub>D</sub> = -2 $V_{GS}$ = -10 V d Maximum Rati	.0 A, 5 Ω (Note 4) .0 A, (Note 4)		9   33   22   25   10   2.1	8.5 30 75 55 60 13 	pF ns ns ns nc nC	
C <sub>oss</sub> C <sub>rss</sub> <b>Switch</b> t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-S</b> I <sub>s</sub>	Output Revers ing Ch. Turn-O Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-D Source Maxim	aracteristics n Delay Time n Rise Time ff Delay Time ff Fall Time ate Charge ource Charge train Charge	istics an Source Dio	f = 1.0 MHz $V_{DD}$ = -200 V, $I_D$ = -2 $V_{GS}$ = -10 V, $R_G$ = 25 $V_{DS}$ = -320 V, $I_D$ = -2 $V_{GS}$ = -10 V d Maximum Rati de Forward Current	.0 A, 5 Ω (Note 4) .0 A, (Note 4)		6.5   9   33   22   25   10   2.1   5.5	8.5 30 75 55 60 13  	ns ns ns nC nC	
C <sub>oss</sub> C <sub>rss</sub> Switch t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-S I <sub>s</sub>	Output Revers ing Ch Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-S Gate-S Gate-S Gate-S Maxim Maxim	e Transfer Capacitance aracteristics n Delay Time n Rise Time ff Delay Time ff Fall Time ate Charge ource Charge orain Charge Diode Character um Continuous Drain-	istics an Source Dioo ce Diode F	f = 1.0 MHz $V_{DD}$ = -200 V, $I_D$ = -2 $V_{GS}$ = -10 V, $R_G$ = 25 $V_{DS}$ = -320 V, $I_D$ = -2 $V_{GS}$ = -10 V d Maximum Rati de Forward Current	.0 A, 5 Ω (Note 4) .0 A, (Note 4) ngs		9   33     22   25     10   2.1     5.5	8.5 30 75 55 60 13   	ns ns ns nC nC nC	
$\begin{array}{c} C_{oss} \\ \hline C_{rss} \\ \hline \end{array} \\ \hline \begin{array}{c} \hline \end{array} \\ \hline \end{array} \\ \hline \end{array} \\ \hline \begin{array}{c} \hline \end{array} \\ \hline \end{array} \\ \hline \end{array} \\ \hline \end{array} \\ \hline \\ \begin{array}{c} t_{t_{d}(off)} \\ t_{f} \\ \hline \\ $	Output Revers ing Ch Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-S Gate-S Gate-S Gate-S Gate-S Gate-S Gate-S	e Transfer Capacitance aracteristics n Delay Time n Rise Time ff Delay Time ff Fall Time ate Charge ource Charge ource Charge train Charge Diode Character um Continuous Drain-Sour	istics an Source Dioo ce Diode F	f = 1.0 MHz $V_{DD}$ = -200 V, $I_D$ = -2 $V_{GS}$ = -10 V, $R_G$ = 25 $V_{DS}$ = -320 V, $I_D$ = -2 $V_{GS}$ = -10 V d Maximum Rati de Forward Current provard Current	.0 A, 5 Ω (Note 4) .0 A, (Note 4) ngs	     	9   33     22   25     10   2.1     5.5	8.5 30 75 55 60 13   -2.0 -8.0	pF ns ns ns nC nC nC A A	

FQP2P40 — P-Channel QFET<sup>®</sup> MOSFET

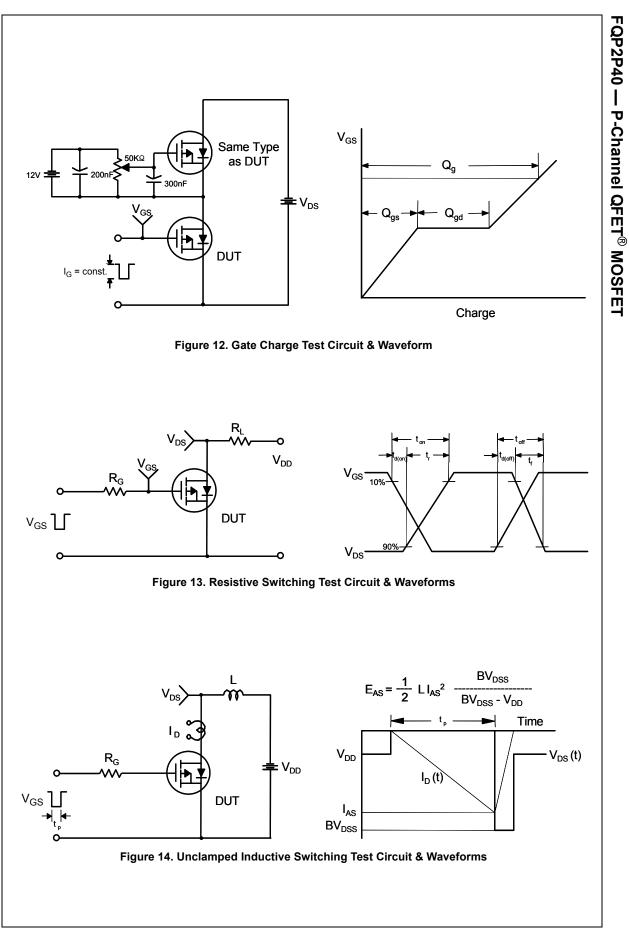
1. Repetitive rating : pulse-width limited by maximum junction temperature. 2. L = 52.5 mH, I<sub>AS</sub> = -2.0 A, V<sub>DD</sub> = -50 V, R<sub>G</sub> = 25  $\Omega$ , Starting T<sub>J</sub> = 25°C. 3. I<sub>SD</sub>  $\leq$  -2.0 A, di/dt  $\leq$  200 A/ $\mu$ s, V<sub>DD</sub>  $\leq$  BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C. 4. Essentially independent of operating temperature.



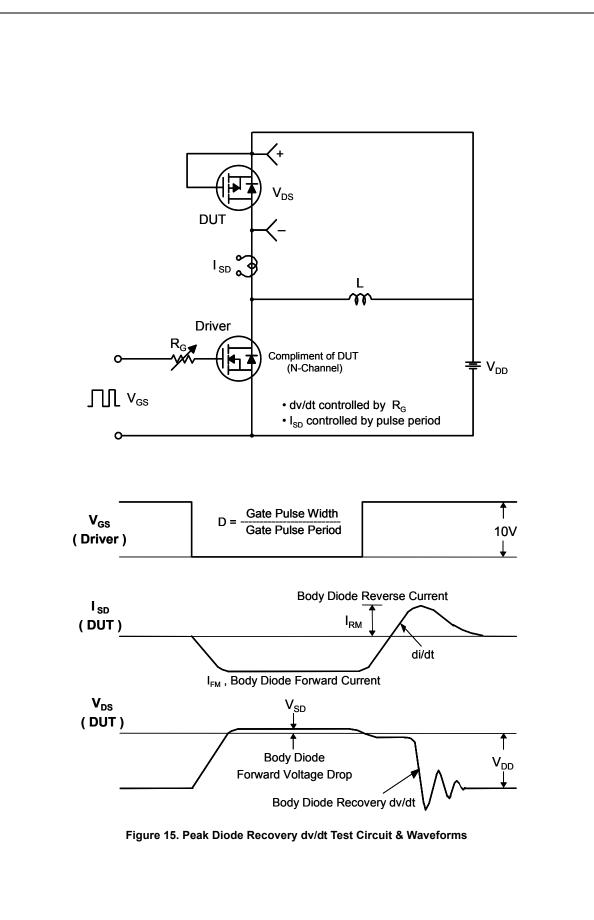
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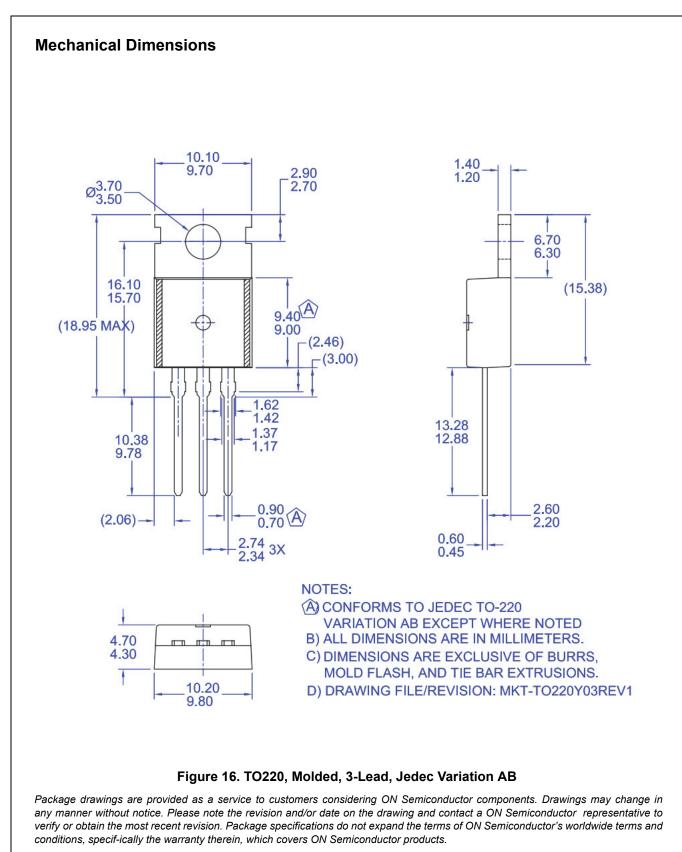


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